

Press Release

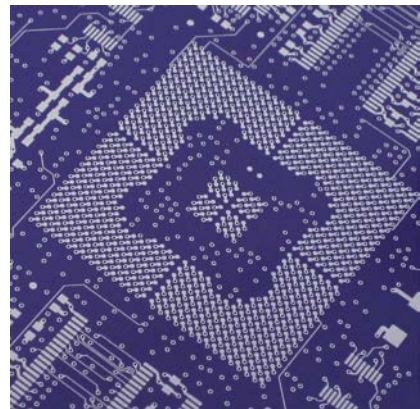
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For immediate release

Technic releases Technistan HTM 4089

New High Throw, Low Cost Tin Process for Improving Yields of Advanced PCB Designs

Cranston RI, USA - Technic has announced the release of [Technistan HTM 4089](#), a High Throw Matt (HTM) tin sulfate process engineered to increase yields in advanced printed circuit boards. The Technistan HTM 4089 additive suppresses deposit thickness on the surface creating a thicker deposit in the center of a high aspect ratio through hole or at the bottom of a blind microvia with a highly consistent, fine grain deposit. This deposit along with its excellent throw provides exceptional resistance to final etchants. In addition, all the components of Technistan HTM 4089 are fully analyzable and extremely stable, resulting in a cost effective solution for improving yields of advanced PCB designs. For more information on Technistan HTM 4089 and Technic's full range of PCB Chemistry Process Controls and Equipment, go to www.technic.com.



Technic Inc. is a US based, private, financially strong corporation. For over 65 years, Technic has been a global supplier of [specialty chemicals](#), [custom finishing equipment](#), [engineered powders](#), and [analytical control systems](#) to the electronic component, printed circuit board, semiconductor, photovoltaic, industrial finishing and decorative industries.

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